

HGTG30N120D2

April 1995

30A, 1200V N-Channel IGBT

JEDEC STYLE TO-247

N-CHANNEL ENHANCEMENT MODE

.

EMITTER COLLECTOR

GATE

Package

COLLECTOR (BOTTOM SIDE

METAL)

Terminal Diagram

Features

- 30A, 1200V
- Latch Free Operation
- Typical Fall Time 580ns
- High Input Impedance
- Low Conduction Loss

Description

The HGTG30N120D2 is a MOS gated high voltage switching device combining the best features of MOSFETs and bipolar transistors. The device has the high input impedance of a MOS-FET and the low on-state conduction loss of a bipolar transistor. The much lower on-state voltage drop varies only moderately between +25°C and +150°C.

The IGBTs are ideal for many high voltage switching applications operating at moderate frequencies where low conduction losses are essential, such as: AC and DC motor controls, power supplies and drivers for solenoids, relays and contactors.

PACKAGING AVAILABILITY

PART NUMBER	PACKAGE	BRAND
HGTG30N120D2	TO-247	G30N120D2
Formerly Developme		

Absolute Maximum Ratings T_C = +25°C, Unless Otherwise Specified

	HGTG30N120D2	UNITS
Collector-Emitter Voltage BV _{CES}	1200	V
Collector-Gate Voltage, R_{GE} =1M Ω V _{CGR}	1200	V
Collector Current Continuous at T _C = +25°C I _{C25}	50	A
at V _{GE} =15V at T _C = +90 ^o C I _{C90}	30	А
Collector Current Pulsed (Note 1)I _{CM}	200	А
Gate-Emitter Voltage ContinuousV _{GES}	±20	V
Gate-Emitter Voltage Pulsed	±30	V
Switching Safe Operating Area at T _J = +150°CSSOA	200A at 0.8 BV _{CES}	-
Power Dissipation Total at $T_{C} = +25^{\circ}C$ P_{D}	208	W
Power Dissipation Total Derating T _C > +25 ^o C	1.67	W/ ^o C
Operating and Storage Junction Temperature Range	-55 to +150	°C
Maximum Lead Temperature for SolderingTL	260	°C
Short Circuit Withstand Time (Note 2) at V _{GE} = 15V t _{SC}	6	μS
at V _{GE} = 10Vt _{SC}	15	μS
NOTES		

NOTES:

1. Repetitive Rating: Pulse width limited by maximum junction temperature.

2. $V_{CE(PEAK)} = 720V, T_C = +125^{\circ}C, R_{GE} = 25\Omega.$

HARRIS SEMICONDUCTOR IGBT PRODUCT IS COVERED BY ONE OR MORE OF THE FOLLOWING U.S. PATENTS	:
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4.364.073	4.417.385	4.430.792	4.443.931	4.466.176	4.516.143	4.532.534	4.567.641	
, = = , = = =	4.598.461	, , -	1 - 1	4.620.211	, , -	1 1	.,,.	
4,587,713	.,,	4,605,948	4,618,872	.,	4,631,564	4,639,754	4,639,762	
4,641,162	4,644,637	4,682,195	4,684,413	4,694,313	4,717,679	4,743,952	4,783,690	
4,794,432	4,801,986	4,803,533	4,809,045	4,809,047	4,810,665	4,823,176	4,837,606	
4,860,080	4,883,767	4,888,627	4,890,143	4,901,127	4,904,609	4,933,740	4,963,951	
4,969,027								

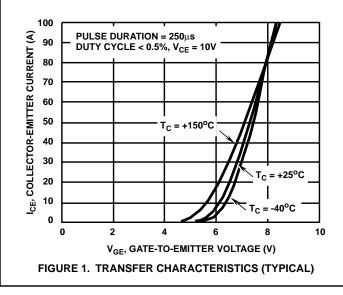
CAUTION: These devices are sensitive to electrostatic discharge; follow proper IC Handling Procedures. http://www.intersil.com or 407-727-9207 | Copyright © Intersil Corporation 1999 3-111

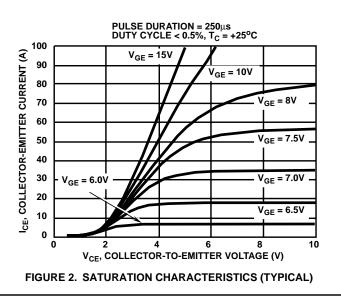
					LIMITS		
PARAMETERS	SYMBOL BV _{CES}	$\label{eq:conditions} \frac{\mbox{TEST CONDITIONS}}{\mbox{I}_{C}=250\mu A, \mbox{V}_{GE}=0 \mbox{V}}$		MIN	TYP	MAX -	UNITS V
Collector-Emitter Breakdown Voltage				1200	-		
Zero Gate Voltage Collector Current	I _{CES}	$V_{CE} = BV_{CES}$	T _C = +25°C	-	-	1.0	mA
		$V_{CE} = 0.8 \text{ BV}_{CES}$	T _C = +125°C	-	-	4.0	mA
Collector-Emitter Saturation Voltage	V _{CE(SAT)}	$I_{C} = I_{C90},$ $V_{GE} = 15V$	T _C = +25°C	-	3.0	3.5	V
			T _C = +125°C	-	3.2	3.5	V
		$I_{\rm C} = I_{\rm C90},$	T _C = +25°C	-	3.2	3.8	V
		V _{GE} = 10V	T _C = +125°C	-	3.4	3.8	V
Gate-Emitter Threshold Voltage	V _{GE(TH)}	$V_{GE} = V_{CE},$ $I_C = 1mA$	$T_{\rm C}$ = +25°C	3.0	4.5	6.0	V
Gate-Emitter Leakage Current	I _{GES}	$V_{GE} = \pm 20V$		-	-	±500	nA
Gate-Emitter Plateau Voltage	V _{GEP}	$I_{C} = I_{C90}, V_{CE} = 0.5 \text{ BV}_{CES}$		-	7.3	-	V
On-State Gate Charge	Q _{G(ON)}	$I_{C} = I_{C90},$ $V_{CE} = 0.5 \text{ BV}_{CES}$	V _{GE} = 15V	-	185	240	nC
			V _{GE} = 20V	-	240	315	nC
Current Turn-On Delay Time	t _{D(ON)I}	L = 50μ H, I _C = I _{C90} , R _G = 25Ω , V _{GE} = $15V$, T _J = $+125^{\circ}$ C, V _{CE} = 0.8 BV _{CES}		-	100	-	ns
Current Rise Time	t _{RI}			-	150	-	ns
Current Turn-Off Delay Time	t _{D(OFF)} I			-	760	990	ns
Current Fall Time	t _{FI}			-	580	750	ns
Turn-Off Energy (Note 1)	W _{OFF}			-	8.4	-	mJ
Current Turn-On Delay Time	t _{D(ON)I}	L = 50μ H, I _C = I _{C90} , R _G = 25Ω , V _{GE} = 10V, T _J = +125°C, V _{CE} = 0.8 BV _{CES}		-	100	-	ns
Current Rise Time	t _{RI}			-	150	-	ns
Current Turn-Off Delay Time	t _{D(OFF)} I			-	610	790	ns
Current Fall Time	t _{FI}			-	580	750	ns
Turn-Off Energy (Note 1)	W _{OFF}	1		-	8.4	-	mJ
Thermal Resistance Junction-to-Case	R _{θJC}			-	0.5	0.6	°C/W

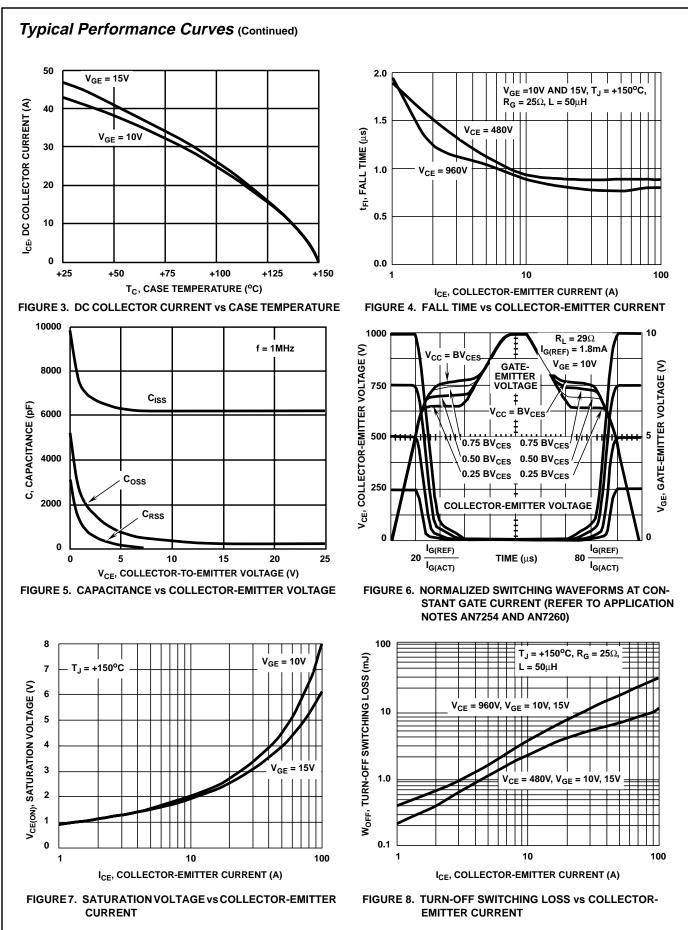
Electrical Specifications $T_{C} = +25^{\circ}C$, Unless Otherwise Specified

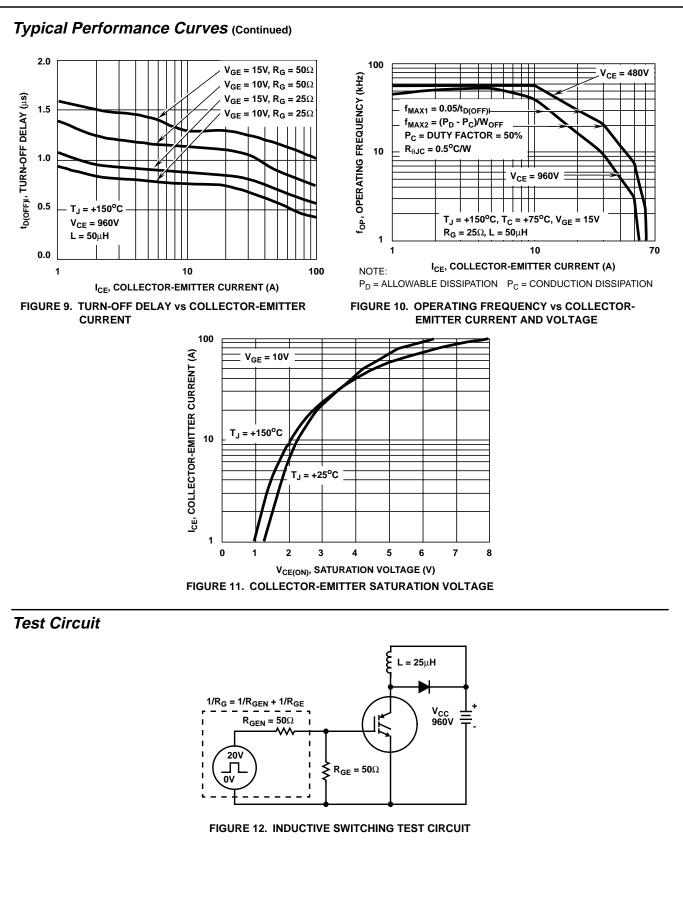
NOTE: 1. Turn-Off Energy Loss (W_{OFF}) is defined as the integral of the instantaneous power loss starting at the trailing edge of the input pulse and ending at the point where the collector current equals zero (I_{CE} = 0A) The HGTG20N100D2 was tested per JEDEC standard No. 24-1 Method for Measurement of Power Device Turn-Off Switching Loss. This test method produces the true total Turn-Off Energy Loss.

Typical Performance Curves









Operating Frequency Information

Operating frequency information for a typical device (Figure 10) is presented as a guide for estimating device performance for a specific application. Other typical frequency vs collector current (I_{CE}) plots are possible using the information shown for a typical unit in Figures 7, 8 and 9. The operating frequency plot (Figure 10) of a typical device shows f_{MAX1} or f_{MAX2} whichever is smaller at each point. The information is based on measurements of a typical device and is bounded by the maximum rated junction temperature.

 f_{MAX1} is defined by $f_{MAX1} = 0.05/t_{D(OFF)I}.\ t_{D(OFF)I}$ deadtime (the denominator) has been arbitrarily held to 10% of the onstate time for a 50% duty factor. Other definitions are possible. $t_{D(OFF)I}$ is defined as the time between the 90% point of the trailing edge of the input pulse and the point where the collector current falls to 90% of its maximum value. Device

turn-off delay can establish an additional frequency limiting condition for an application other than T_{JMAX} . $t_{D(OFF)I}$ is important when controlling output ripple under a lightly loaded condition.

 f_{MAX2} is defined by f_{MAX2} = $(P_D - P_C)/W_{OFF}$. The allowable dissipation (P_D) is defined by P_D = $(T_{JMAX} - T_C)/R_{\theta JC}$. The sum of device switching and conduction losses must not exceed P_D . A 50% duty factor was used (Figure 10) and the conduction losses (P_C) are approximated by P_C = $(V_{CE} \bullet I_{CE})/2$. W_{OFF} is defined as the integral of the instantaneous power loss starting at the trailing edge of the input pulse and ending at the point where the collector current equals zero (I_{CE} = 0A).

The switching power loss (Figure 10) is defined as $f_{MAX2} \bullet W_{OFF}.$ Turn-on switching losses are not included because they can be greatly influenced by external circuit conditions and components.

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Sales Office Headquarters

NORTH AMERICA

Intersil Corporation P. O. Box 883, Mail Stop 53-204 Melbourne, FL 32902 TEL: (407) 724-7000 FAX: (407) 724-7240

EUROPE

Intersil SA Mercure Center 100, Rue de la Fusee 1130 Brussels, Belgium TEL: (32) 2.724.2111 FAX: (32) 2.724.22.05

ASIA

Intersil (Taiwan) Ltd. Taiwan Limited 7F-6, No. 101 Fu Hsing North Road Taipei, Taiwan Republic of China TEL: (886) 2 2716 9310 FAX: (886) 2 2715 3029